

# Enhanced Laser Inkless Printer

Final Presentation  
Group 5

# Meet the E.L.I.P. Team



Jack McCain

Electrical Engineer



Miguelangel Otero

Optics & Photonics Engineer



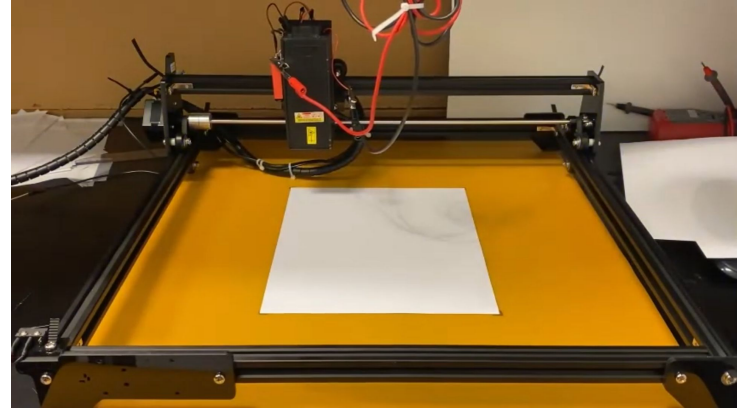
Sarah Siverio

Computer Engineer

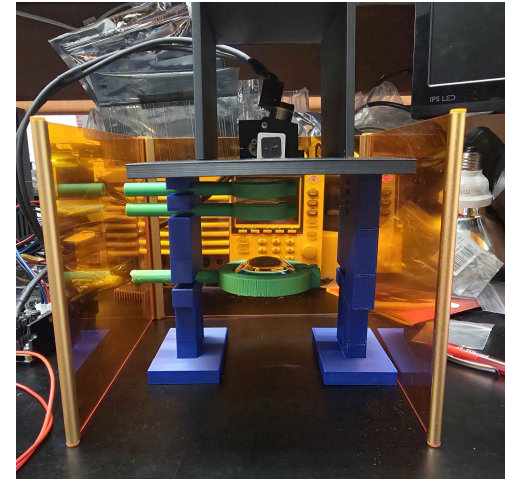
# Motivation and Background

- Printers are an essential technology in the home and office space.
  - The ink cartridges used by these printers pose great financial and environmental risks over the long term.
- In 2020, SD2 Group 2 designed the Laser Inkless Printer (L.I.P.).
  - It was able to mark messages out on paper via pixel designs, successfully showcasing the proof of concept for this technology.
- We were inspired by their idea and message, and hope to iterate and advance upon the design.
  - Specifically, improving in the areas of speed, reliability, and system integration.

Original L.I.P.



E.L.I.P.



# Requirement Specifications

Engineering Requirements	Engineering Specifications	Parameters
Input Processing speed	The system will process inputs from an external source within a specified time frame.	$\leq 1s$
Laser error margin	The X and Y axis motors will move the laser to the correct location within a certain margin of error.	$\leq 5 \text{ mm}$
Safe temperature	The system will maintain safe operating temperature during printing to ensure safety for users.	$\leq 150 \text{ }^\circ\text{F}$
Printing Speed	The system will complete a full-page print within a specified time frame	$\leq 120s$
Print Resolution	The system will achieve a minimum print resolution to make each letter readable, should exceed that of the previous design.	$\geq 30 \text{ DPI}$
Printer Weight	The system will not exceed a weight that would make it not portable.	$\leq 25 \text{ lbs}$
Printer Size	The system will be able to be fixed on a standard desk.	30" x 60"
Output Linewidth	The resulting marks should be fine and legible, like when writing with a pencil..	$\leq 0.9 \text{ mm}$



# Goals

# Objectives

B - Utilize alternative technologies to advance upon the previous design.

Develop a laser galvanometer-based system to improve on the print speed of the previous design.

B - Expand upon the character list, ensuring fine and legible marking on paper.

Implement a multi-lens design to proper focus and correct for mirror adjustments.

B - Ensure user-friendly operation.

Utilize a basic LCD interface for updates and control inputs.

A - Integrate bluetooth or USB connectivity for wireless/remote print commands.

Store print logs and diagnostics in non-volatile memory, allowing persistent data across power cycles.

A - Incorporate safety error detection (e.g., motor stall detection, laser shut off due to overheating).

Implement dynamic power scaling for idle subsystems, and maintaining a set threshold of power consumption during operation.

S - Enable higher-resolution printing (>600 dpi) for more detailed text or graphics.

Investigate machine learning techniques for adaptively optimize print speed and path planning for different document layouts.

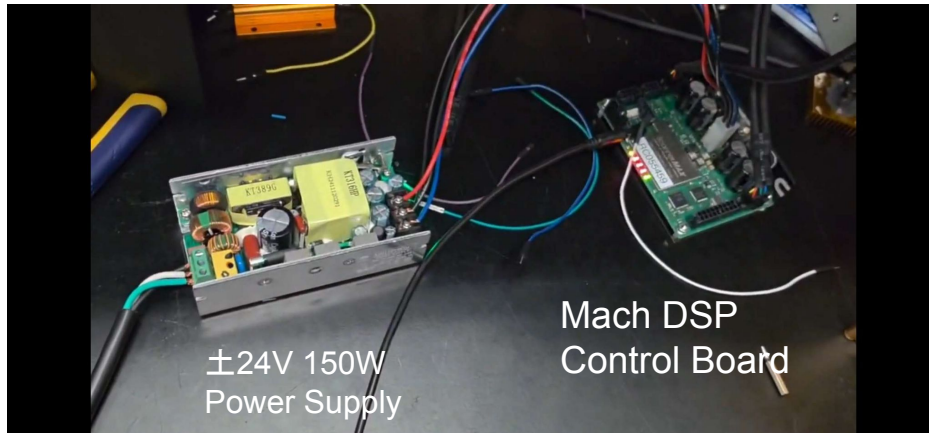
S - Implement capabilities for adjustable font size.

Incorporating a means of pulse-width modulation of the laser to vary burn depth or darkness.



# The Laser Galvanometer (Galvo)

- Custom ordered galvanometer, primary variation for the E.L.I.P.'s design
  - Difficulty in finding a reliable galvo from cost effective retailers like Amazon.
- Contact with ScannerMax proved very fruitful.
  - Provided us a quote for their Compact 506 galvanometer.
  - Attached are some of the included parts for the galvanometer.



# Laser Comparison

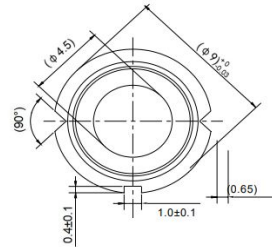
	Green Laser Diode	Blue Laser Diode	Nd: YAG Laser
Wavelength [nm]	530	445	1064
Average Power [W]	0.6 - 2.75	6 - 8	25
Beam Quality [M <sup>2</sup> ]	>2	1 - 1.1	1.2 - 1.7
Beam Divergence [mrad]	0.4	0.2	0.34
Lifetime [h]	25,000	30,000	830 (lamp)

- Nd:YAG, while well researched and effective, had too many cons if implemented.
- Blue provided an excellent mix of benefits that outweighed its negatives for the previous design.
- Green is capable of engraving non-paper materials (e.g., xTools), but was disregarded in the previous design.

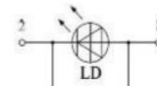


# Selected Laser Diode

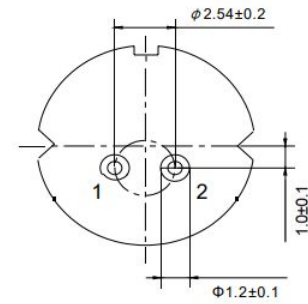
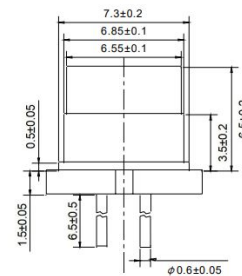
- LaserTree Green Laser Zener Diode:  $530 \pm 2$  nm
- Multimode
- Built-in Fast Axis Collimation Lens (FAC)
- Optical Output Power: 1.65 W
- Forward Current: 2.3 A
- Operating Voltage: 4.0 - 5.5 V
- Parallel Divergence:  $0.2 - 0.6^\circ$
- Perpendicular Divergence:  $-1.0 - 1.0^\circ$



Connection

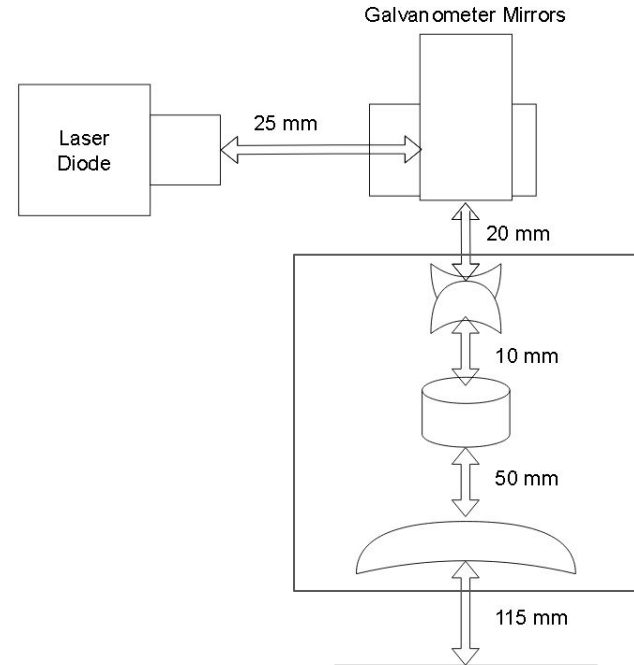
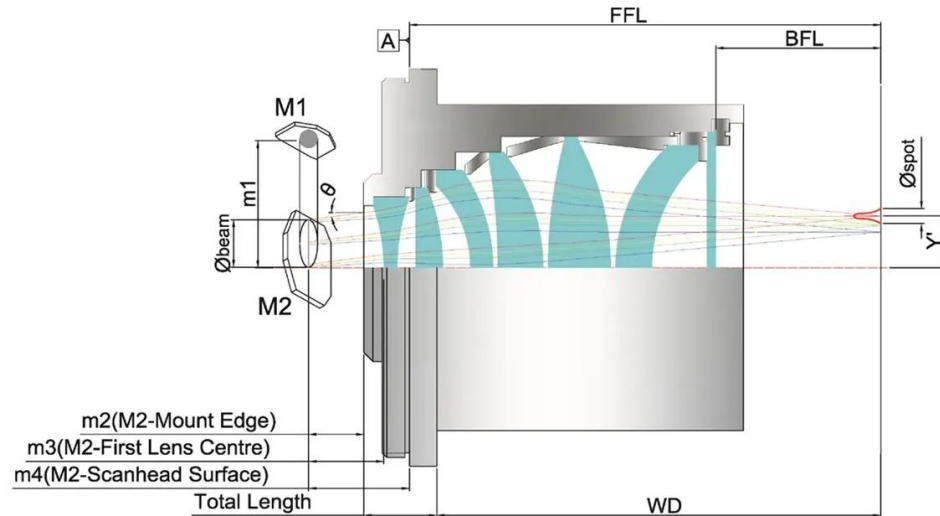


1. LD Anode  
2. LD Cathode



# Optical Hardware Components-Lenses

- For effective galvo usage, flat-field image plane is required.
  - Focused Diode → Mirror Reflection → “F-Theta” Setup



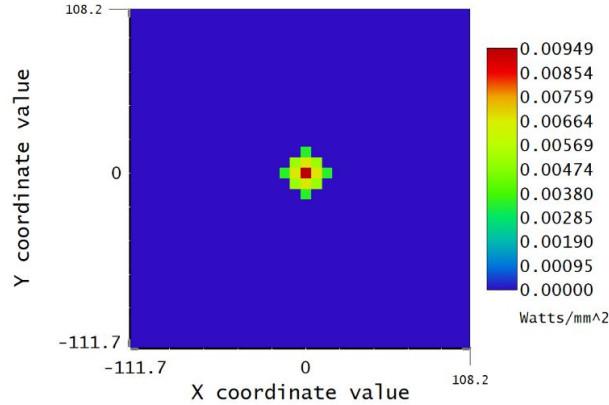
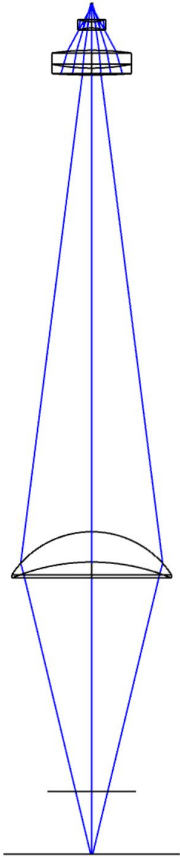
# Lens, Power, and Spot Size Calculations

- Effective focal length calculations
  - $d_{AB} = 10 \text{ mm}$ ,  $d_{BC} = 50 \text{ mm}$
- $f_{AB} = (1/f_{biconcave} + 1/f_{achromatic} - d_{AB}/(f_{biconcave} * f_{achromatic}))^{-1}$
- $f_{eff} = (1/f_{AB} + 1/f_{meniscus} - d_{BC}/(f_{AB} * f_{meniscus}))^{-1}$ 
  - $f_{eff} = 115.4 \text{ mm}$
- Power loss calculations
  - For each lens surface:  $P_t = P_{in} * (1 - T)^n$
  - For the reflectance of the mirrors:  $P_r = P_{in} * R$ 
    - $P_{out} = 1.5385 \text{ W}$
- Diffraction Limited Spot Size
  - $M^2 = 2$
- $D_s = (1.27 * M^2 * 530 \text{ nm} * 115 \text{ mm}) / 4.5 \text{ mm}$ 
  - $D_s = 34.5 \mu\text{m}$

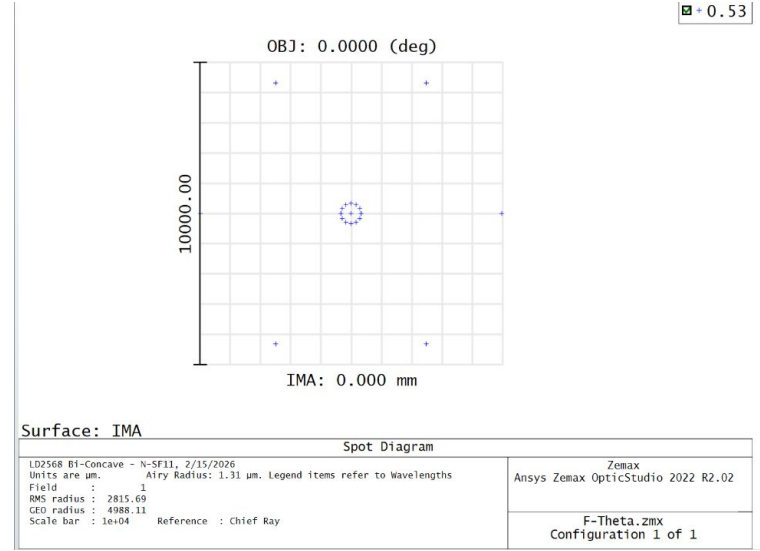
Biconcave Lens	D = 9 mm Coating = 350 - 700 nm f = -9 mm
Achromatic Doublet Lens	D = 25.4 mm Coating = 400 - 700 nm f = 150 mm
Positive Meniscus Lens	D = 50.8 mm Coating = 350 - 700 nm f = 100 mm



# Lens Simulation Results



Total Irradiance surface 10
LD2568 Bi-Concave - N-SF11, 2/15/2026
Beam wavelength is 0.53000 $\mu\text{m}$ in the media with index 1.00000 at 0.0000 (deg)
Display X Width = 2.2336E+02, Y Height = 2.2336E+02 Millimeters
Peak Irradiance = 9.4875E-03 Watts/Millimeters <sup>2</sup> , Total Power = 3.4186E+00 Watts
Pilot: Size= 2.2336E+01, Waist= 1.0841E-03, Pos= -1.4353E+02, Rayleigh= 6.9663E-03
Beam Width X = 1.30059E+01, Y = 1.30059E+01 Millimeters



# Paper Analysis

Astrobrights: Interstellar Pinks

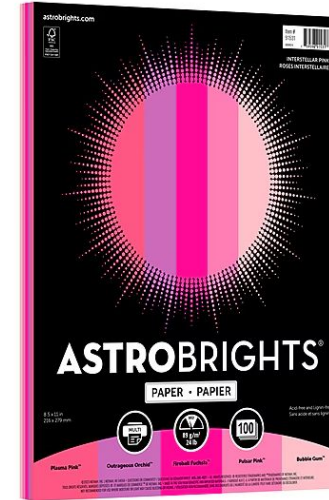
Magenta colored - complementary to green

Weight: 89 g/sm

Estimated Thickness: 0.0045 - 0.005 in

20% thicker than standard paper

Lignin and Acid-free



# Comparison of software

- Embedded Control, OS, and Communication Technologies

Component	Options Considered	Key Comparison Factors	Selected
MCU Platform	Arduino, STM32, ESP32	Real-time capability, wireless integration, processing headroom	ESP32
Operating Model	Superloop, TI-RTOS, FreeRTOS	Determinism, task scheduling, synchronization	FreeRTOS
Firmware Language	Python, MicroPython, C/C++	Latency, hardware control, timing accuracy	C/C++
Wireless Protocol	USB/UART, Wi-Fi, BLE	Latency, mobility, system integration	BLE (NimBLE)



# Microcontroller comparison

Microcontroller	Advantages	Disadvantages	Approx. Cost
STM32F4	Built-in DACs, strong RTOS support. Supports Ethernet for network integration.	Higher complexity in development compared to Arduino boards.	\$14-20
Teensy 4.1	Extremely fast Cortex-M7 core, strong library support, excellent for high frequency control	No built-in DAC on 4.x series, requires external DAC hardware.	\$29-35
Raspberry Pi Pico	Very low cost, strong support, PIO state machines allow precise waveform generation.	No onboard DAC; Ethernet/networking requires additional hardware	\$4-6
ESP32	Integrated Wi-Fi and Bluetooth, moderate real-time performance, supports FreeRTOS by default.	Limited DAC resolution, high jitter for precision tasks	\$5-10
STM32WB	Dual-core architecture(Cortex-M4 + M0+) with integrated Bluetooth low energy. Built-in DAC for precise galvo control.	Slightly higher development complexity due to dual-core coordination and BLE stack management	\$10-15



# Selection of software

- Selected Software Architecture

Layer	Technology	Rationale
Firmware Platform	ESP32 + FreeRTOS	Dual-core isolation of real-time control and communication tasks.
Control Logic	C/C++	Low-latency DAC control, direct hardware access
Task Management	FreeRTOS	Preemptive scheduling, priority inheritance, watchdog supervision
Communication	BLE (NimBLE)	Low-latency wireless control and OTA firmware updates
User Interface	nRF Connect	Protocol compatibility, BLE support, testing flexibility



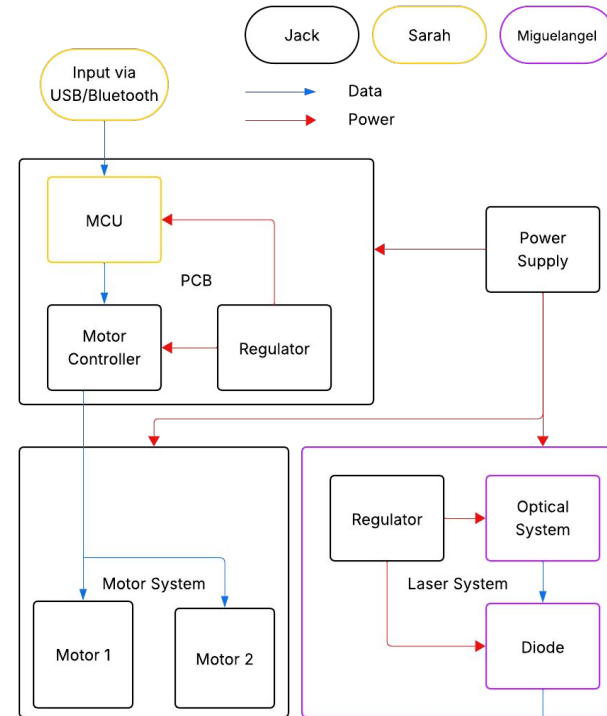
# Regulator Comparison

Regulator	Advantages	Disadvantages	Approx. Cost
Linear (LM7805)	Simple, low noise	Less efficient, generates more heat	\$0.5-1
Buck (LM2596T)	Up to 3A output, wide input range, high efficiency, already comfortable with it.	Moderate output ripple	\$1.50
Buck (TPS5430)	3A output, reliable with good efficiency	Not as comfortable with compared to LM2596T	\$2-4



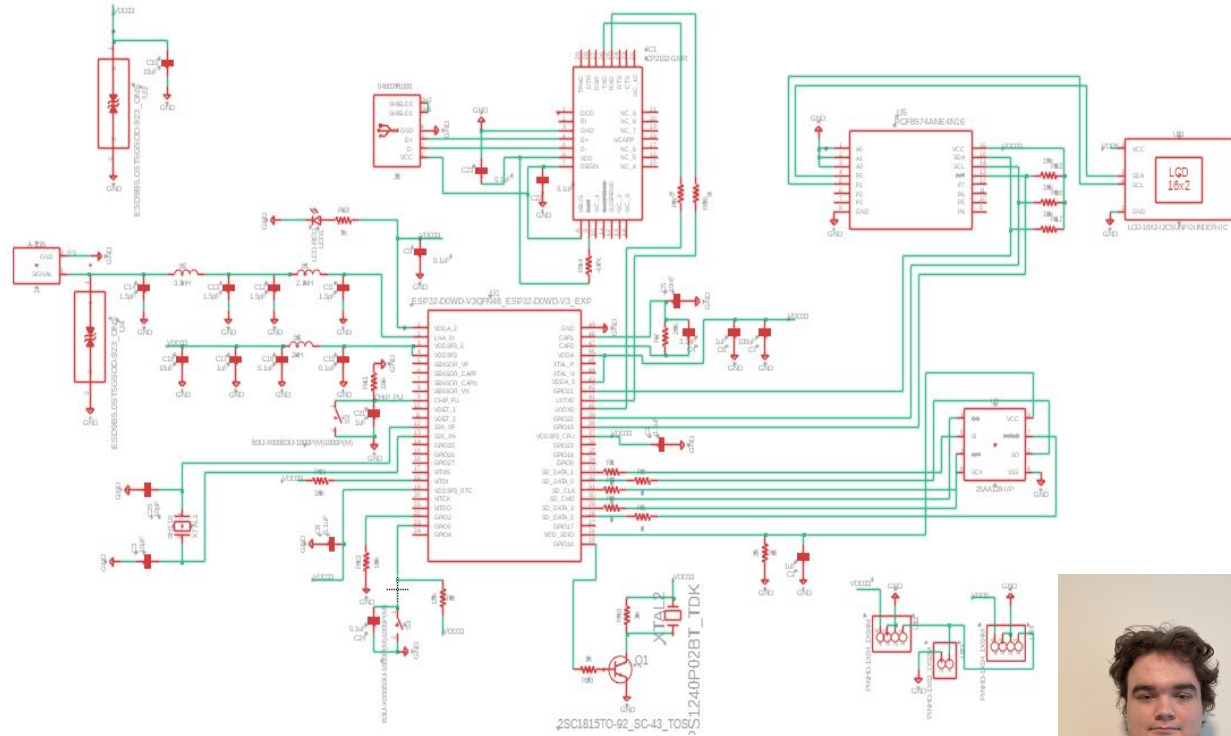
# Hardware Block Diagram

- **Hardware Goals:**
  - Maintain stable output voltages in PSU and regulators.
  - Ensure the components don't overheat
  - Ensure data is able to be reliably transferred between MCU and Motor Controller
- **Overview:**
  - Data fed into MCU via USB/Bluetooth
  - MCU transfers data to Motor Controller
  - Motor Controller uses data to move galvo motors into position



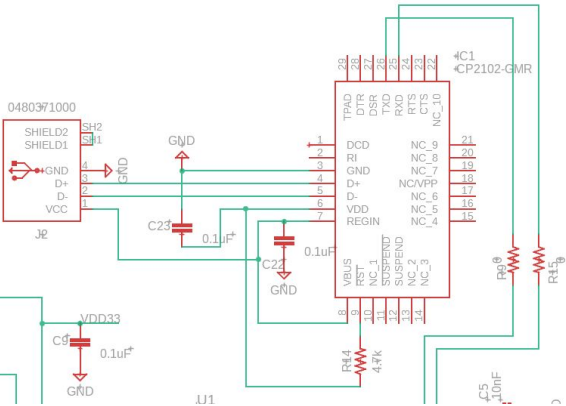
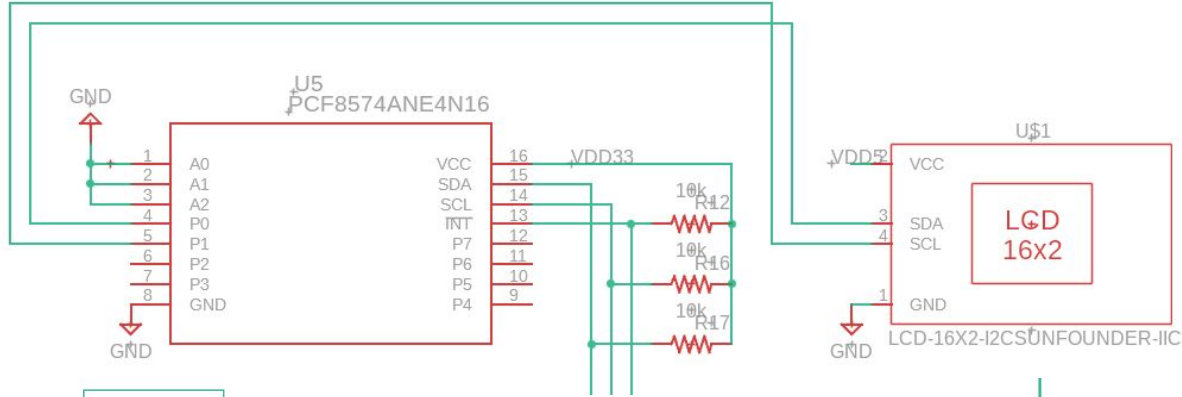
# PCB Design: MCU

- ESP32
- Antenna for improved bluetooth performance
- Connected to regulators with 1x4 pin headers



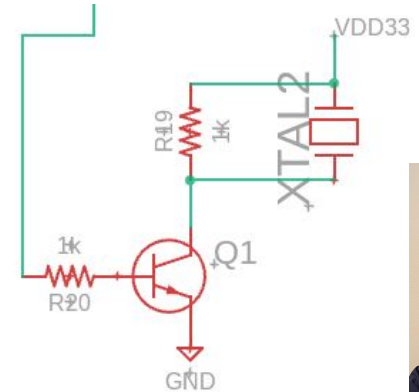
# PCB Design: ESP32 peripherals

LCD using  
PCF8574  
for I2C



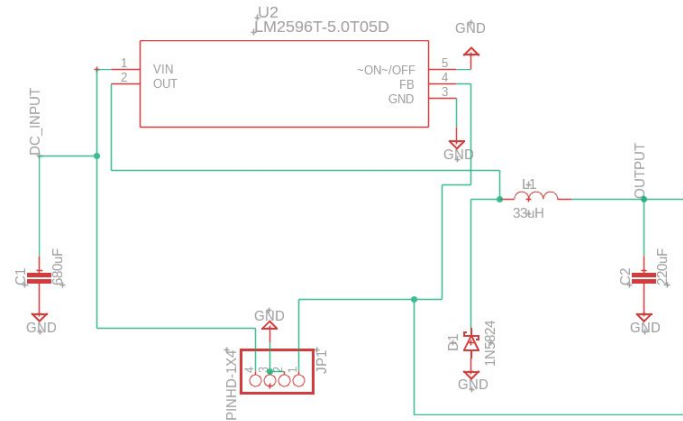
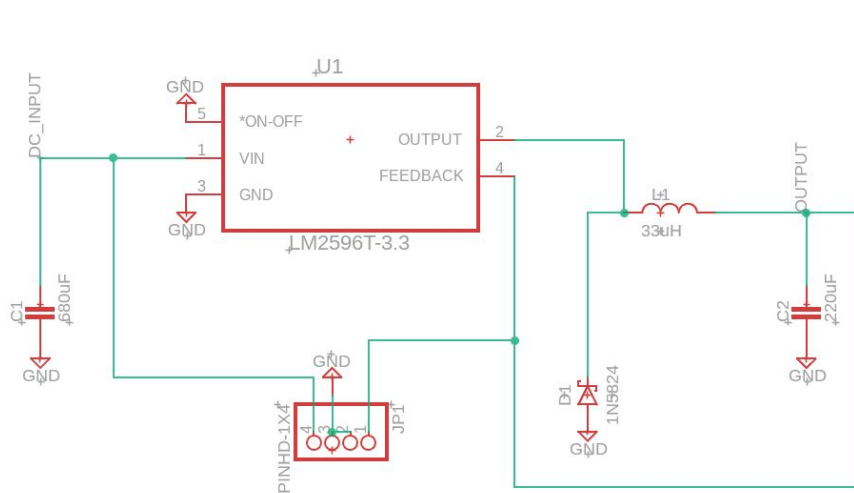
USB-A  
with  
CP2102  
Serial  
Bridge

Buzzer



# PCB Design: 3.3V and 5V regulator schematics

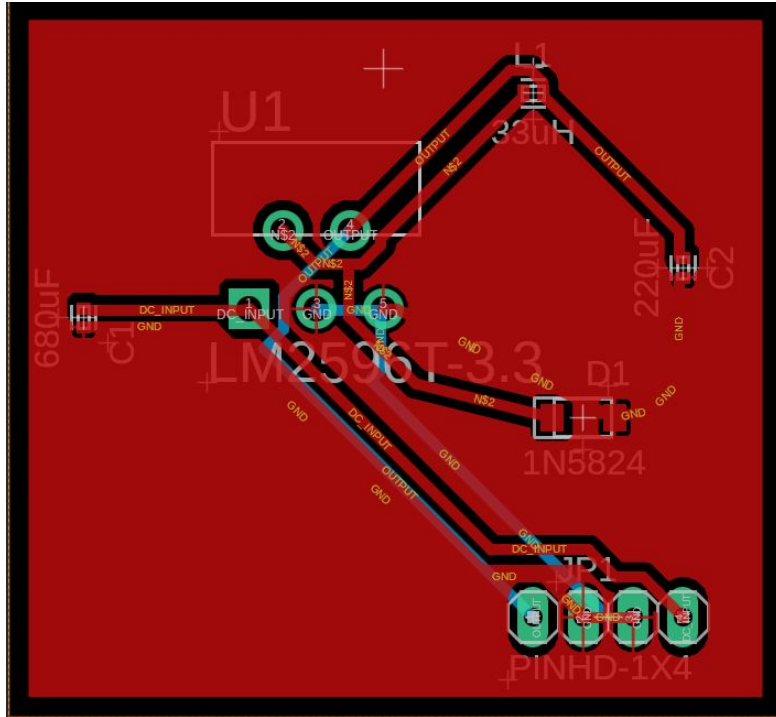
- 3.3V powers most peripherals on the MCU
- 5V powers the LCD and laser diode driver



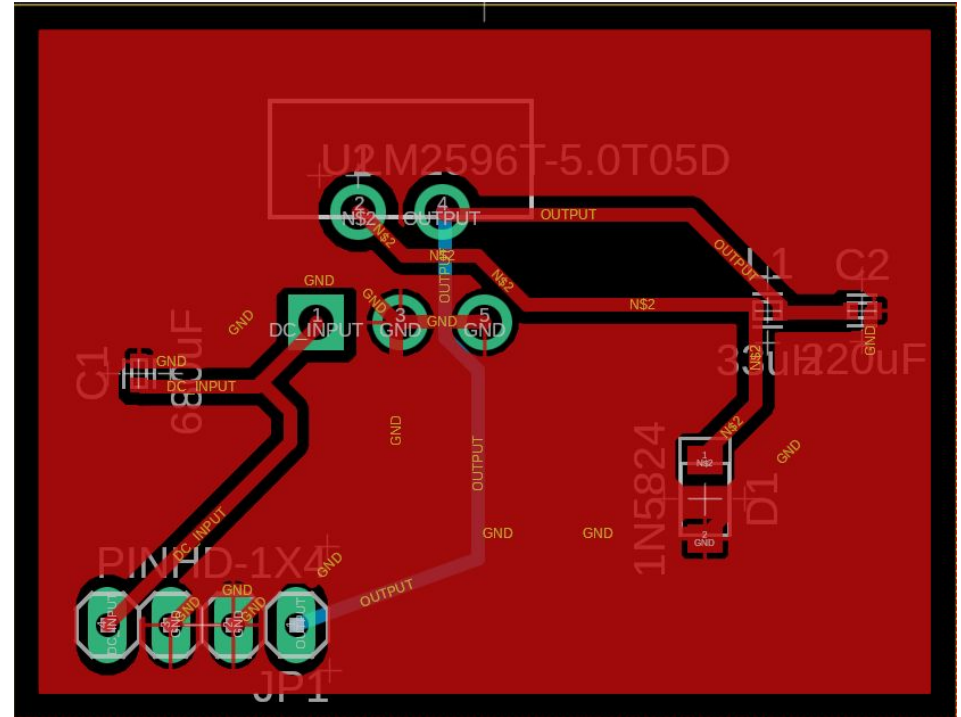
# PCB Design: 3.3V and 5V regulator pcb



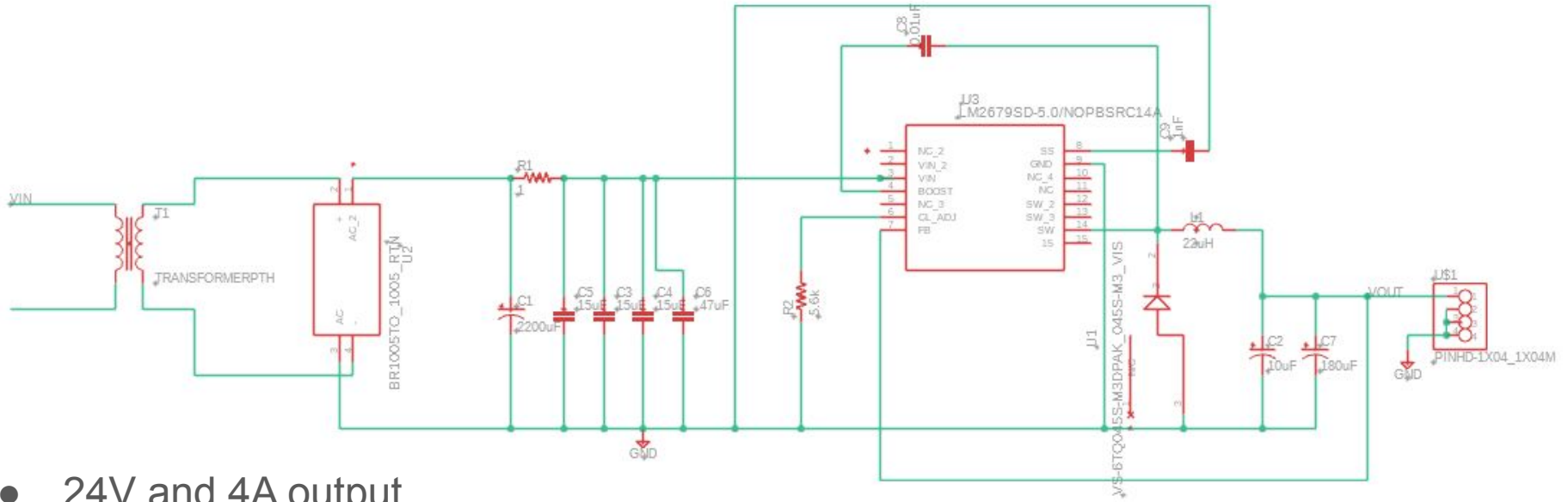
3.3V



5V



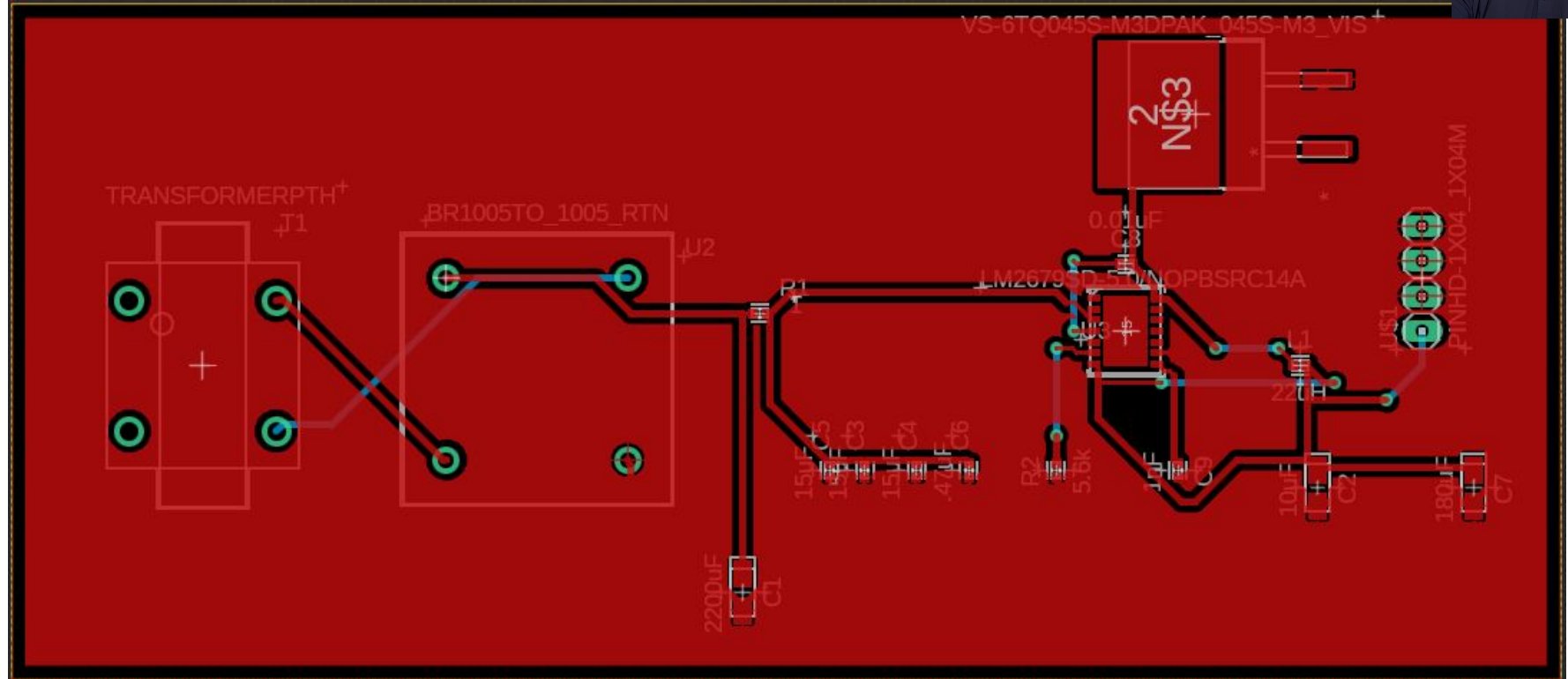
# PCB Design: Power Supply schematic



- 24V and 4A output
- Regulated by 3.3V and 5V regs on the MCU
- LM2679SD recommended by Dr. Weeks



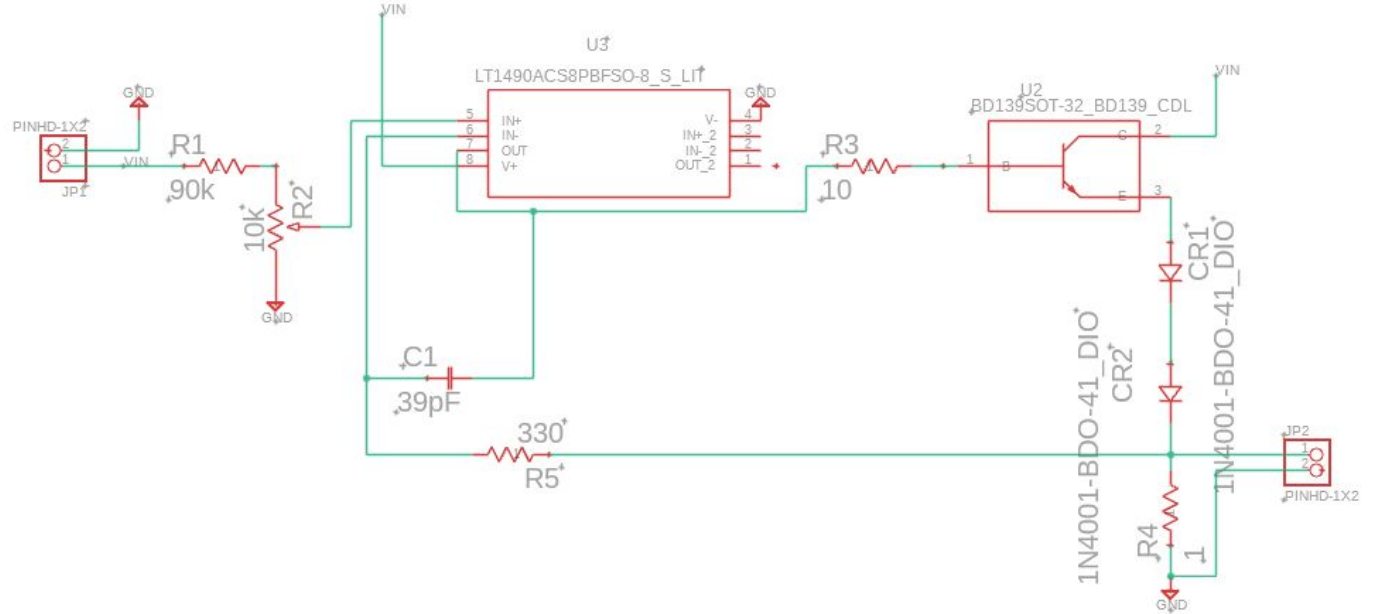
# PCB Design: Power Supply schematic



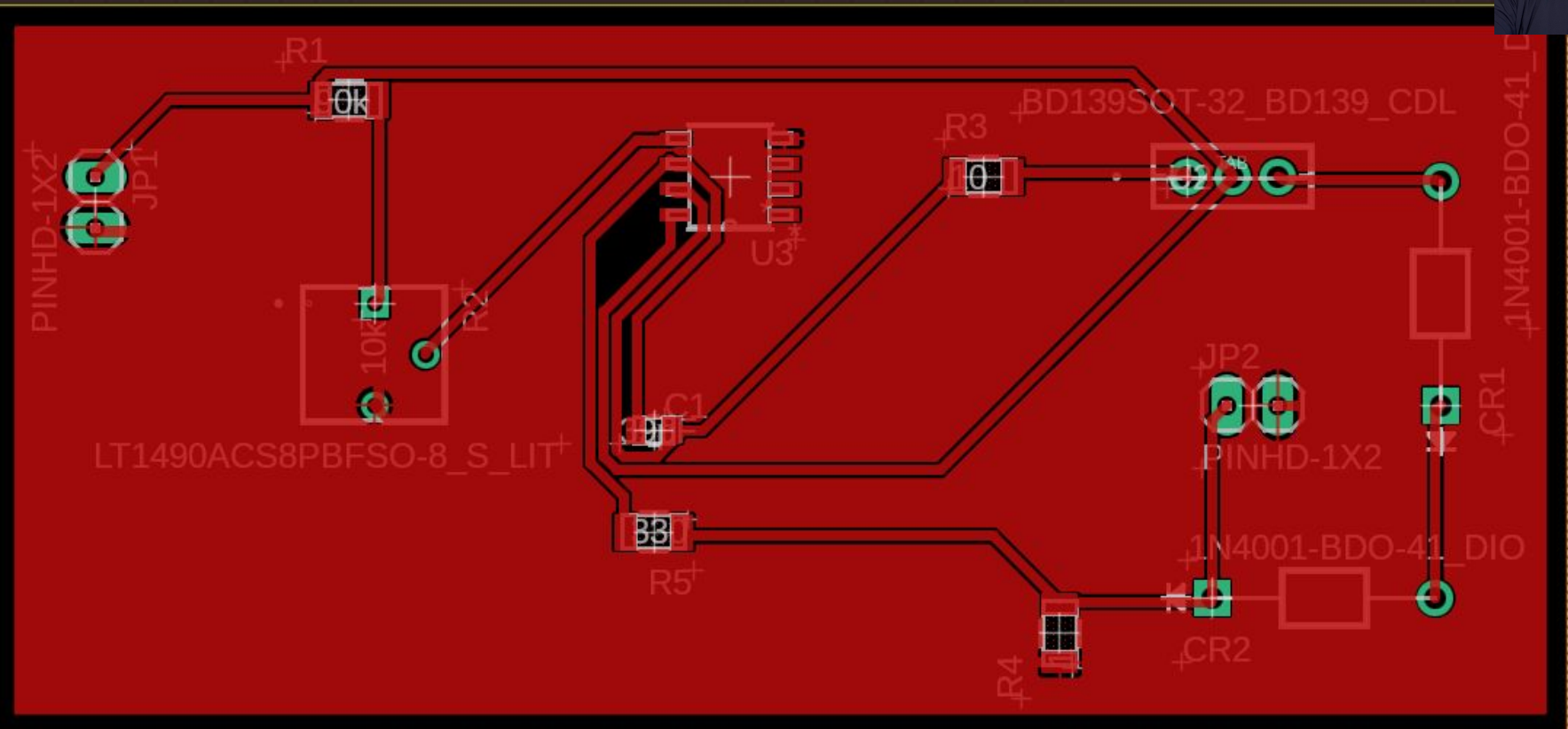
# PCB Design: Laser Diode Driver schematic



- 5V, 0-500mA laser diode driver
- Connected to 5V regulator on MCU board

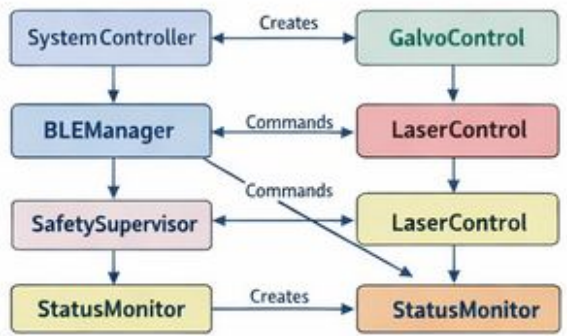


# PCB Design: Laser Diode Driver

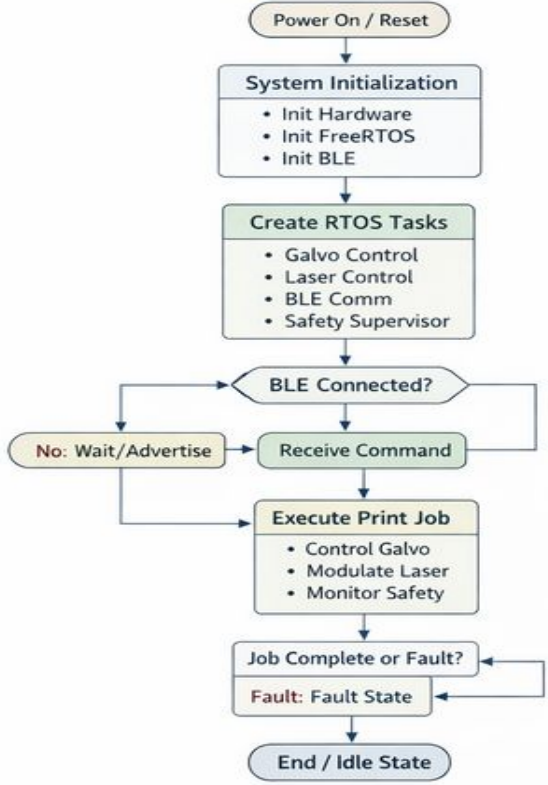


# Software Design

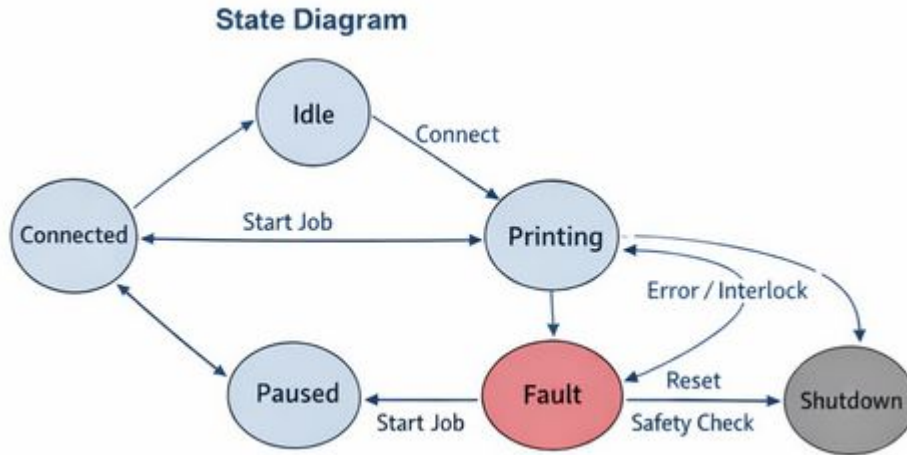
Class Diagram



System Flowchart



# Software Design Cont.

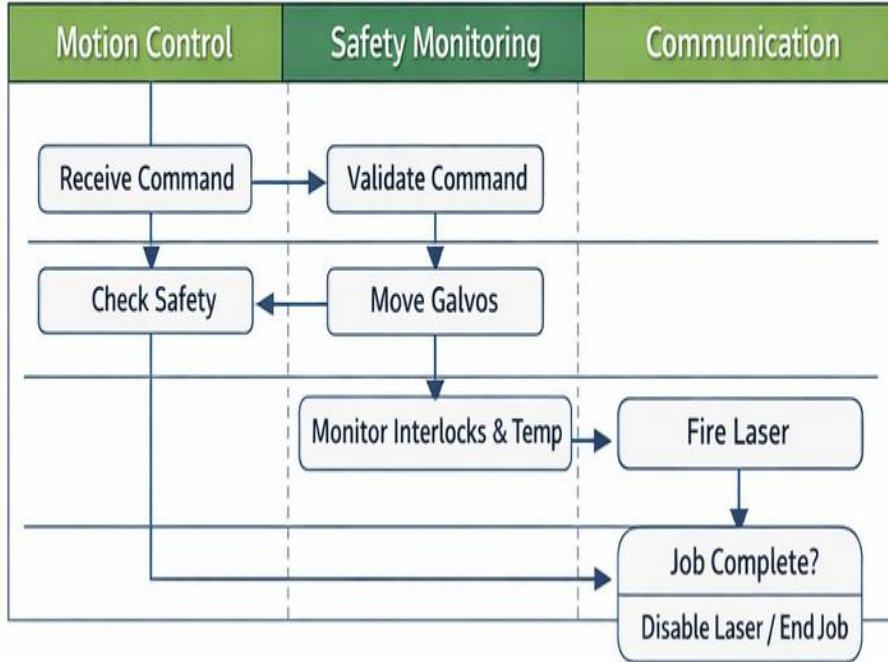


- The system operates using a **finite state machine (FSM)** implemented within the ESP32 firmware.
- Upon BLE connection, the system transitions from **Idle** -> **Connected**, enabling command reception
- When a valid job command is received, the controller enters the Printing state, where galvo motion and laser firing are actively managed.
- If a safety violation or interlock trigger the system transitions immediately to the **Fault** state.



# Software Design Cont.

Activity Diagram



## 1. Motion Control

- Receives validated motion commands from the communication layer.
- Converts command data into galvo positioning updates
- Coordinates laser enable timing

## Safety Monitoring

- Continuously monitors hardware interlocks
- Validates each command before execution
- Can interrupt motion and disable the laser in real-time if violation is detected.

## Communication

- Handles BLE commands & job status updates
- Determines job completion conditions
- Ensures laser is disabled at the end of a job

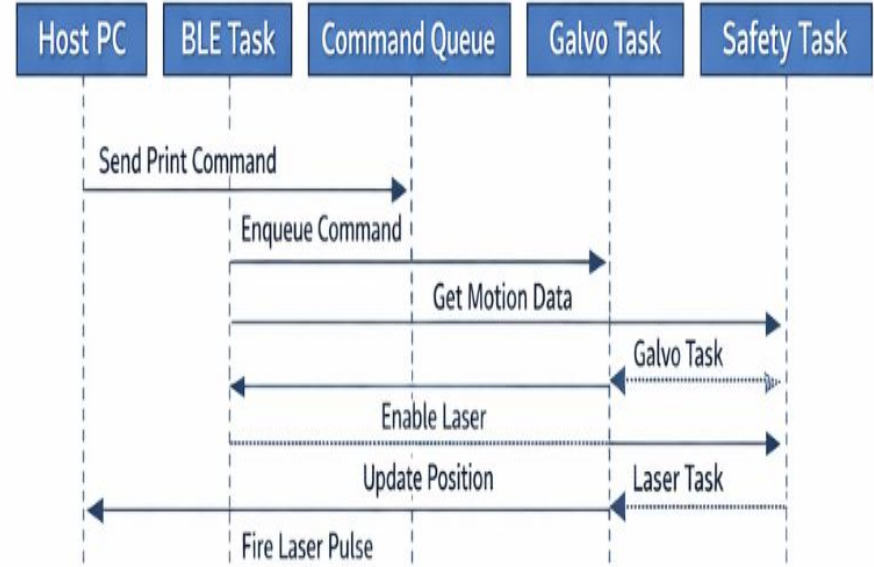


# Software Design Cont.

## Real-Time Command Execution Flow

1. The Host PC sends a print command over BLE.
2. The **BLE Task** receives and parses the command.
3. The command is placed into a **FreeRTOS** queue for processing.
4. The **Galvo Task** retrieves motion data and updates mirror positioning.
5. The **Safety Task** verifies conditions before enabling the laser.
6. Once Cleared, the system:
  - Enables the laser
  - Updates galvo position
7. The system repeats this cycle until job completion.

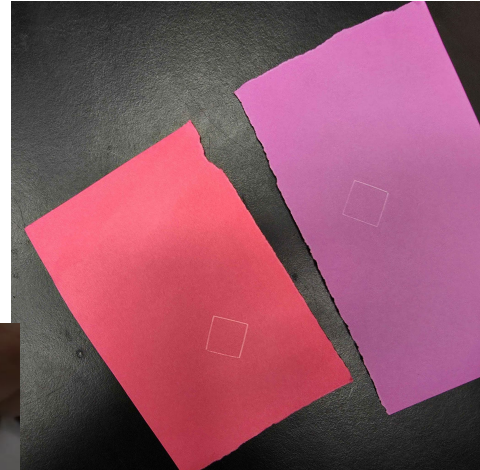
## Sequence Diagram



CPE/EE Results near the end

# Paper Results

- The darker shades worked best for visible marks without damaging the paper.
  - Lighter shades produced less visible marks.
  - Width of designs were within specification.



# Optical Problems, Difficulty, and Solutions

- Ineffective heat management of the diode.
  - Resolved by, per reviewer recommendation, to purchase an aluminum socket.
- Failure to mark at initial prototype stage, prior to galvanometer movement.
  - Resolved after removing the initial aspheric lens and moving the laser diode closer. The fast axis collimating lens helped.
- Failure to mark at calculated effective focal length after galvanometer movement.
  - Resolved but adjusting system height from Pos. Meniscus from 115 mm to approximately 68 mm. Significant Change of Diffraction Limited Spot Size.
- Critical diode failure near the final deadline.
  - Partially resolved with the help of Group 2 providing us a diode of higher power UV diode. Replacement was ordered, but expected to arrive later.

### DIFFRACTION LIMITED SPOT SIZE

Wavelength:  nm

Effective Focal Length (EFL):  mm

Beam Diameter (D):  mm

Laser Beam Quality (M2):

#### INSTRUCTIONS

Fill in the following:  
1. Laser wavelength  
2. EFL  
3. Beam Diameter  
4. Laser Beam Quality

#### NOTES

- The user may choose different units in any field

### RESULTS

Input Beam Divergence (full): 0.2999 mrad

Diffraction-Limit Spot size ( $\omega 0$ ): 34.49  $\mu\text{m}$

Rayleigh length: 891.43 micrometers

### DIFFRACTION LIMITED SPOT SIZE

Wavelength:  nm

Effective Focal Length (EFL):  mm

Beam Diameter (D):  mm

Laser Beam Quality (M2):

#### INSTRUCTIONS

Fill in the following:  
1. Laser wavelength  
2. EFL  
3. Beam Diameter  
4. Laser Beam Quality

#### NOTES

- The user may choose different units in any field

### RESULTS

Input Beam Divergence (full): 0.2999 mRad

Diffraction-Limit Spot size ( $\omega 0$ ): 20.39  $\mu\text{m}$

Rayleigh length: 308.18 micrometers



# Budget



Component	Part Number/Number	Quantity	Unit Price
Green Laser Diode	<a href="#">Laser Diode LT-LD-530-1650M-C</a>	1	\$130.00
Calipers	Amazon	1	\$8.00
Safety Goggles	EaglePairOD7+ 190nm - 540nm	1	\$54.00
Safety Window	<a href="#">Foldable Laser Shield</a>	1	\$100.00
ScannerMAX Galvanometer	Compact 506	1	\$2,316.80
Aluminum Diode Socket	JLCPCB	1	\$48.00
Biconcave Lens	LD2568-A	1	\$ 44.81
Achromatic Doublet Lens	AC254-150-A	1	\$ 95.34
Positive Meniscus Lens	LE1076-A	1	\$ 61.64
PCBs	JLCPCB	4	~\$150.00
PCB Parts	DigiKey	~50	~250.00
Fans + Heatsinks	Amazon	3	\$15.00
Paper	Astrobrights: Interstellar Pinks	1	\$7.00
Filament	Bambu PLA, Polymaker ASA	3	\$65.00
ESP32	<a href="#">ESP32-DevKitC-32</a>	6	\$28.26
Stepper Board	<a href="#">Amazon</a>	1	\$10.39
Tentative Total			\$Recalculate

# Work Distribution



Jack McCain: EE

- ESP32 Design
- Power System
- PCB Building



Miguelangel Otero: PSE

- Lens and laser system design
- 3D printed housing designs



Sarah Siverio: CPE

- ESP32 Firmware Development
- BLE Communication Integration
- System Control & Task Management (FreeRTOS)

Thank you for watching!